

PTC thermistors as limit temperature sensors

SMD, EIA case sizes 0603 and 0805, standard series

 Series/Type:
 B59601, B59602, B59603, B59604, B59701

 Date:
 February 2012

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Limit temperature sensors, EIA sizes 0603 and 0805

Standard series

SMD

Applications

- DC/DC converters
- Home appliances
- Dimmers
- Electronic ballasts
- Over-temperature protection of power components
- Secondary protection of battery packs
- SMPS
- Notebooks

Features

- Fast and reliable response
- Suitable for reflow soldering only
- Compliant to RoHS directive 2002/95/EC
- UL approval to UL1434 for B59601A* (file number E69802)
- Lead-free tinned terminations

Options

Other T_{sense} or resistance values on request

Delivery mode

- Blister tape (case size 0805) or cardboard tape (case size 0603), 180-mm reel with 8-mm tape, taping to IEC 60286-3
- Packing unit: 4.000 pcs.

General technical data

Max. operating voltage		V _{max}	32	V DC
Minimum operating temperature	$(V \le V_{max})$	T_{min}	-40	°C
Maximum operating temperature	$(V \le V_{max})$	T_{max}	125 °C or $T_{sense,1}$ +25 °C	°C
			whichever is higher	



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Electrical specifications and ordering codes

Case size 0603

R _R	ΔR_{R}	T _{sense,1}	R	Ordering code
$(V \le V_{max})$		(@ 4.7 kΩ)	(T _{sense,1} +10 °C)	_
Ω	%	°C	kΩ	
EIA case size	0603, stand	ard types		
470	±50	75 ±5	-	B59601A0075A062
470	±50	85 ±5	-	B59601A0085A062
470	±50	95 ±5	-	B59601A0095A062
470	±50	105 ±5	-	B59601A0105A062
470	±50	115 ±5	-	B59601A0115A062
470	±50	125 ±5	-	B59601A0125A062
470	±50	135 ±5	-	B59601A0135A062
EIA case size	0603, tight t	emperature tole	rance types	
470	±50	75 ±3	-	B59601A0075B062
470	±50	85 ±3	≥ 15	B59601A0085B062
470	±50	95 ±3	≥ 40	B59601A0095B062
470	±50	105 ±3	≥ 40	B59601A0105B062
470	±50	115 ±3	≥ 40	B59601A0115B062
470	±50	125 ±3	≥ 40	B59601A0125B062
470	±50	135 ±3	≥ 40	B59601A0135B062

Note:

In order to limit self heating effects the electrical power during measurement should be below 4 mW for case size 0603.



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Electrical specifications and ordering codes

Case size 0603 and 0805

R _R	ΔR_{R}	T_{sense}	R	R	R	Ordering code
$(V \le V_{max})$			$(T_{sense,1} - 5^{\circ}C)$	$(T_{sense,1}+5^{\circ}C)$	(T _{sense,1} +15°C)	-
Ω	%	°C	kΩ	kΩ	kΩ	
EIA case siz	ze 0603,	tight res	istance tolerand	e types		
110	±15	70	≤ 1.1	≥ 1.1	-	B59602A0055B062
470	±15	55	≤ 4.7	≥ 4.7	-	B59603A0055A062
470	±15	85	≤ 4.7	≥ 4.7	-	B59603A0085A062
470	±15	105	≤ 4.7	≥ 4.7	-	B59603A0105A062
EIA case size 0805, standard types						
680	±50	70	≤ 5.7	≥ 5.7	$\geq 40^{1)}$	B59701A0070A062
680	±50	90	≤ 5.5	≥ 13.3	≥ 40	B59701A0090A062
680	±50	100	≤ 5.5	≥ 13.3	≥ 40	B59701A0100A062
680	±50	110	≤ 5.5	≥ 13.3	≥ 40	B59701A0110A062
680	±50	120	≤ 5.5	≥ 13.3	≥ 40	B59701A0120A062
680	±50	130	≤ 5.5	≥ 13.3	≥ 40	B59701A0130A062
680	±50	140	≤ 5.5	≥ 13.3	≥ 40	B59701A0140A062

Note:

In order to limit self heating effects the electrical power during measurement should be below 4 mW for case size 0603 and below 6 mW for case size 0805.

¹⁾ R (T_{sense,1} +25 °C)



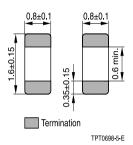
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Standard series

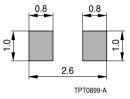
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Dimensional drawings in mm

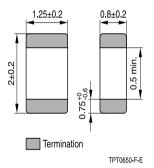
EIA case size 0603



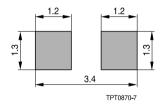
Solder pad



EIA case size 0805



Solder pad



Recommended maximum dimensions (mm)



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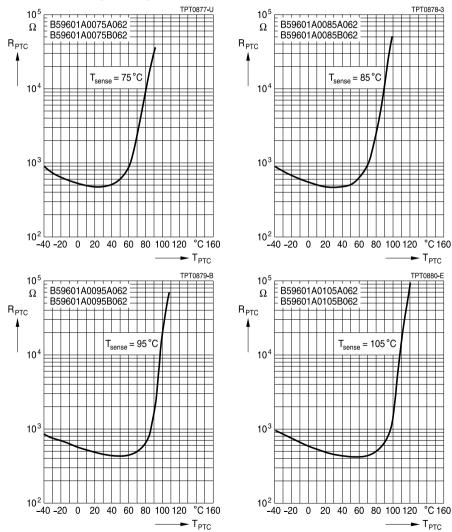
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Characteristics (typical) for type A601

PTC resistance R_{PTC} versus

PTC temperature T_{PTC}

(measured at low signal voltage)





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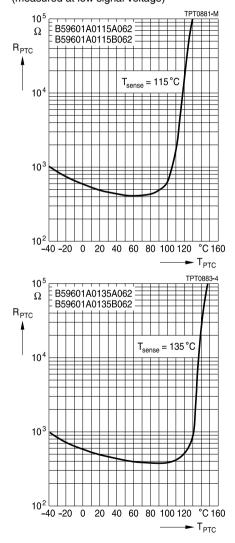
Standard series

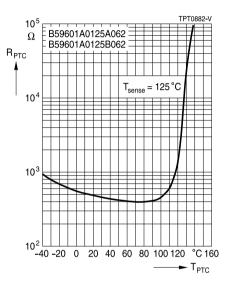
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Characteristics (typical) for type A601

PTC resistance R_{PTC} versus PTC temperature T_{PTC}

(measured at low signal voltage)







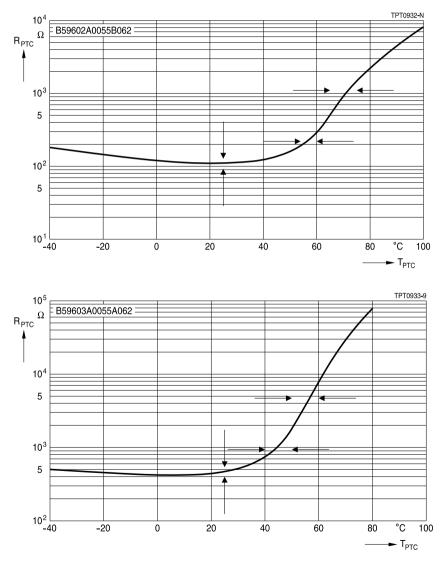
Limit temperature sensors, EIA sizes 0603 and 0805

Standard series

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Characteristics (typical) for type A602 and A603

PTC resistance $R_{\mbox{\tiny PTC}}$ versus PTC temperature $T_{\mbox{\tiny PTC}}$ (measured at low signal voltage)





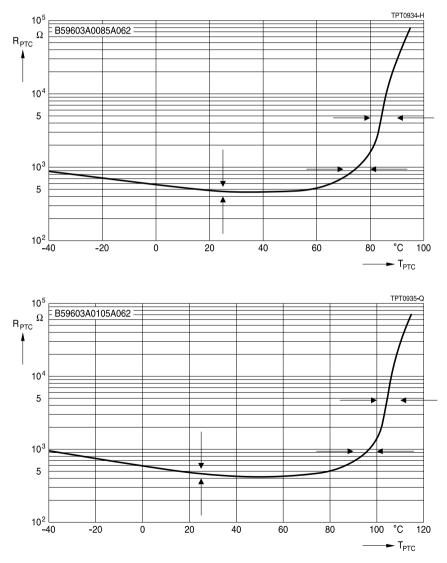
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Standard series

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Characteristics (typical) for type A603

PTC resistance R_{PTC} versus PTC temperature T_{PTC} (measured at low signal voltage)





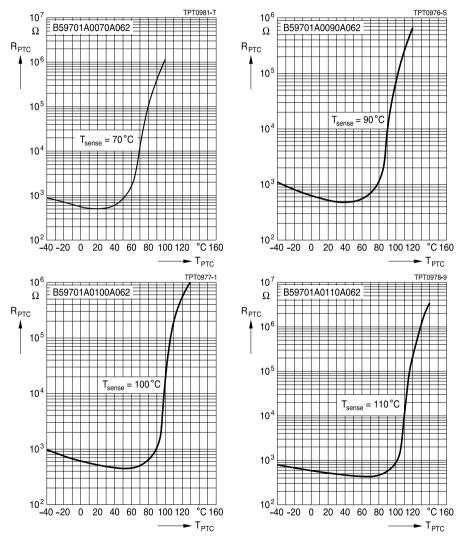
Limit temperature sensors, EIA sizes 0603 and 0805

Standard series

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Characteristics (typical) for type A701

PTC resistance R_{PTC} versus PTC temperature T_{PTC} (measured at low signal voltage)





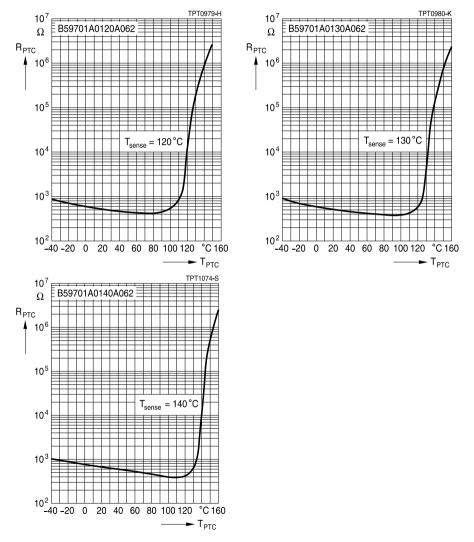
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Characteristics (typical) for type A701

PTC resistance R_{PTC} versus PTC temperature T_{PTC} (measured at low signal voltage)





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Reliability data

Test	Standard	Test conditions	$ \Delta R_{25}/R_{25} $
Electrical endurance,	IEC 60738-1	Room temperature: I _{smax} , V _{max} ;	< 20%
cycling		Number of cycles: 100	
Electrical endurance,	IEC 60738-1	Storage at V _{max} /T _{op}	< 25%
constant		Test duration : 1000 h	
Damp heat	IEC 60738-1	Temperature of air: 40 °C	< 10%
		Relative humidity of air: 93%	
		Duration: 56 days	
		Test according to IEC 60068-2-78	
Rapid change	IEC 60738-1	$T_{LCT} = -40 \ ^{\circ}C, \ T_{UCT} = 125 \ ^{\circ}C$	< 10%
of temperature		Number of cycles: 5	
		Test duration: 30 min	
		Test according to IEC 60068-2-14, test Na	
Vibration	IEC 60738-1	Frequency: 10 - 55 - 10 Hz	< 5%
		Displacement amplitude: 0.75 mm	
		Test duration: 3×2 h	
		Test according to IEC 60028-2-6, test Fc	
Shock	IEC 60738-1	Pulse shape: half-sine	< 5%
		Acceleration: 390 m/s ²	
		Pulse duration: 6 ms; 6 x 4000 pulses	
		Test according to IEC 60068-2-27, test Ea	
Climatic sequence	IEC 60738-1	Dry heat: T _{UCT} = 125 °C	< 10%
		Test duration: 16 h	
		Damp heat first cycle	
		Cold: $T_{LCT} = -40 \ ^{\circ}C$	
		Test duration: 2 h	
		Damp heat 5 cycles	
		Tests performed according to	
		IEC 60068-2-30	
Bending test	IEC 60738-1	Components reflow-soldered to test board	< 5%
		Maximum bendig: 2 mm	
		Test according to IEC 60068-2-21, test Ue	
Adhesive strength on		Shearing of the component soldered on PCB	No
PCB		by a force of 5 N normal to components	visible
	1	longitudinal axis	damage



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Cautions and warnings

General

- EPCOS thermistors are designed for specific applications and should not be used for purposes not identified in our specifications, application notes and data books unless otherwise agreed with EPCOS during the design-in-phase.
- Ensure suitability of thermistor through reliability testing during the design-in phase. The thermistors should be evaluated taking into consideration worst-case conditions.

Storage

- Store thermistors only in original packaging. Do not open the package before storage.
- Storage conditions in original packaging: storage temperature -25 °C ... +45 °C, relative humidity ≤75% annual mean, maximum 95%, dew precipitation is inadmissible.
- Avoid contamination of thermistors surface during storage, handling and processing.
- Avoid storage of thermistor in harmful environment with effect on function on long-term operation (examples given under operation precautions).
- Use thermistor within the following period after delivery:
 - Through-hole devices (housed and leaded PTCs): 24 months
 - Motor protection sensors, glass-encapsulated sensors and probe assemblies: 24 months
 - Telecom pair and quattro protectors (TPP, TQP): 24 months
 - Leadless PTC thermistors for pressure contacting: 12 months
 - Leadless PTC thermistors for soldering: 6 months
 - SMDs in EIA sizes 3225 and 4032, and for PTCs with metal tags: 24 months
 - SMDs in EIA sizes 0402, 0603, 0805 and 1210: 12 months

Handling

- PTCs must not be dropped. Chip-offs must not be caused during handling of PTCs.
- Components must not be touched with bare hands. Gloves are recommended.
- Avoid contamination of thermistor surface during handling.

Soldering (where applicable)

- Use rosin-type flux or non-activated flux.
- Insufficient preheating may cause ceramic cracks.
- Rapid cooling by dipping in solvent is not recommended.
- Complete removal of flux is recommended.
- Standard PTC heaters are not suitable for soldering.



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Mounting

- Electrode must not be scratched before/during/after the mounting process.
- Contacts and housing used for assembly with thermistor have to be clean before mounting. Especially grease or oil must be removed.
- When PTC thermistors are encapsulated with sealing material, the precautions given in chapter "Mounting instructions", "Sealing and potting" must be observed.
- When the thermistor is mounted, there must not be any foreign body between the electrode of the thermistor and the clamping contact.
- The minimum force of the clamping contacts pressing against the PTC must be 10 N.
- During operation, the thermistor's surface temperature can be very high. Ensure that adjacent components are placed at a sufficient distance from the thermistor to allow for proper cooling at the thermistors.
- Ensure that adjacent materials are designed for operation at temperatures comparable to the surface temperature of thermistor. Be sure that surrounding parts and materials can withstand this temperature.
- Avoid contamination of thermistor surface during processing.

Operation

- Use thermistors only within the specified temperature operating range.
- Use thermistors only within the specified voltage and current ranges.
- Environmental conditions must not harm the thermistors. Use thermistors only in normal atmospheric conditions. Avoid use in deoxidizing gases (chlorine gas, hydrogen sulfide gas, ammonia gas, sulfuric acid gas etc), corrosive agents, humid or salty conditions. Contact with any liquids and solvents should be prevented.
- Be sure to provide an appropriate fail-safe function to prevent secondary product damage caused by abnormal function (e.g. use VDR for limitation of overvoltage condition).



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Symbols and terms

A	Area
С	Capacitance
C _{th}	Heat capacity
f	Frequency
I	Current
l _{max}	Maximum current
I _R	Rated current
I _{res}	Residual current
I _{PTC}	PTC current
l,	Residual currrent
I _{r,oil}	Residual currrent in oil (for level sensors)
I _{r,air}	Residual currrent in air (for level sensors)
I _{RMS}	Root-mean-square value of current
l _s	Switching current
I _{Smax}	Maximum switching current
LCT	Lower category temperature
Ν	Number (integer)
N _c	Operating cycles at V_{max} , charging of capacitor
N _f	Switching cycles at V_{max} , failure mode
Р	Power
P ₂₅	Maximum power at 25 °C
P _{el}	Electrical power
P_{diss}	Dissipation power
R _G	Generator internal resistance
R _{min}	Minimum resistance
R _R	Rated resistance
ΔR_{R}	Tolerance of R _R
R _P	Parallel resistance
R _{PTC}	PTC resistance
R _{ref}	Reference resistance
R _s	Series resistance
R ₂₅	Resistance at 25 °C
R _{25,match}	Resistance matching per reel/ packing unit at 25 °C
ΔR_{25}	Tolerance of R ₂₅
Т	Temperature
t —	Time
T _A	Ambient temperature
t _a	Thermal threshold time

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Sensors	
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T _c	Ferroelectric Curie temperature
t _E	Settling time (for level sensors)
T _R	Rated temperature
T_{sense}	Sensing temperature
T _{op}	Operating temperature
T _{PTC}	PTC temperature
t _R	Response time
T _{ref}	Reference temperature
T _{Rmin}	Temperature at minimum resistance
t _s	Switching time
T _{surf}	Surface temperature
UCT	Upper category temperature
V or V_{el}	Voltage (with subscript only for distinction from volume)
V _{c(max)}	Maximum DC charge voltage of the surge generator
$V_{\text{F,max}}$	Maximum voltage applied at fault conditions in protection mode
V _{RMS}	Root-mean-square value of voltage
V _{BD}	Breakdown voltage
V _{ins}	Insulation test voltage
$V_{\text{link,max}}$	Maximum link voltage
V _{max}	Maximum operating voltage
$V_{max,dyn}$	Maximum dynamic (short-time) operating voltage
V _{meas}	Measuring voltage
$V_{\text{meas,max}}$	Maximum measuring voltage
V _R	Rated voltage
V _{PTC}	Voltage drop across a PTC thermistor
α	Temperature coefficient
Δ	Tolerance, change
δ_{th}	Dissipation factor
$ au_{th}$	Thermal cooling time constant
λ	Failure rate
е	Lead spacing (in mm)

Abbreviations / Notes

SMD Surface-mount devices

* To be replaced by a number in ordering codes, type designations etc.

+ To be replaced by a letter

All dimensions are given in mm.

The commas used in numerical values denote decimal points.

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